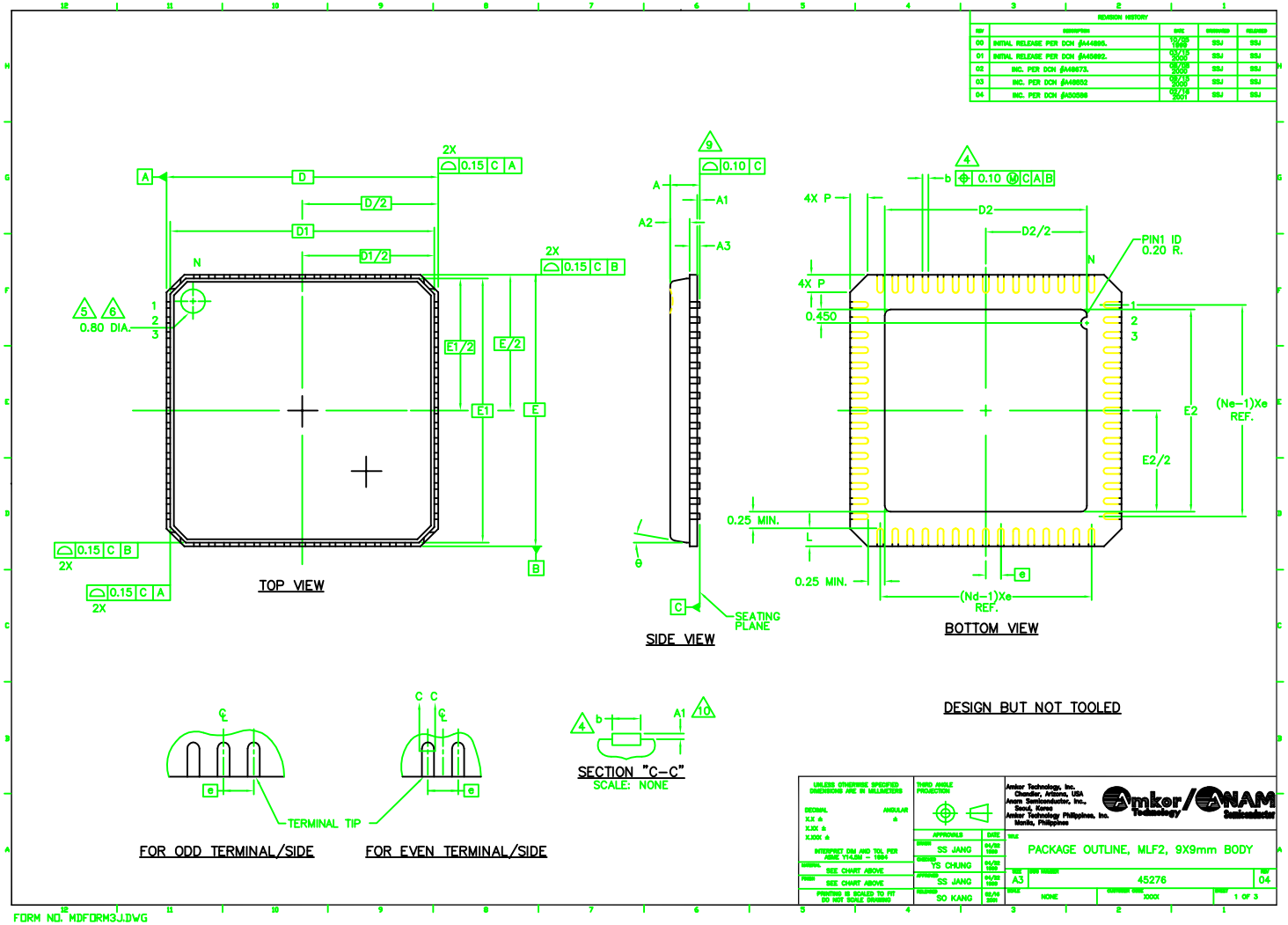
REVISION HISTORY
00 INITIAL RELEASE PER DCN #A44695. 10/08/99 SSJ SSJ
01 INITIAL RELEASE PER DCN #A45692. 03/13/00 SSJ SSJ
02 INC. PER DCN #A48673. 06/08/00 SSJ SSJ
03 INC. PER DCN #A48852 06/13/00 SSJ SSJ
04 INC. PER DCN #A50288 06/13/01 SSJ SSJ
2X 0.15 C A
2X 0.15 C B
A
D
D/2
D1
D1/2
N
5 6
0.80 DIA.
1
2
3
E1/2
E/2
E1
E
B
2X 0.15 C B
2X 0.15 C A
TOP VIEW
9 0.10 C
A
A1
A2
A3
θ
C
SEATING PLANE
SIDE VIEW
4 b 0.10 M C A B
4X P
D2
D2/2
PIN1 ID
0.20 R.
4X P
0.450
N
1
2
3
E2
E2/2
(Ne-1)Xe
REF.
0.25 MIN.
L
0.25 MIN.
e
(Nd-1)Xe
REF.
BOTTOM VIEW
DESIGN BUT NOT TOOLED
C C
℄
e
TERMINAL TIP
FOR ODD TERMINAL/SIDE
FOR EVEN TERMINAL/SIDE
4 b A1 10
SECTION "C-C"
SCALE: NONE
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS
DECIMAL X.X ± X.XX ± X.XXX ±
ANGULAR ±
INTERPRET DIM AND TOL PER ASME Y14.5M - 1994
MATERIAL SEE CHART ABOVE
FINISH SEE CHART ABOVE
PRINTING IS SCALED TO FIT DO NOT SCALE DRAWING
THIRD ANGLE PROJECTION
APPROVALS DATE
DRAWN SS JANG 04/08 1999
CHECKED YS CHUNG 04/08 1999
APPROVED SS JANG 04/08 1999
RELEASED SO KANG 04/08 2001
Amkor Technology, Inc. Chandler, Arizona, USA
Anam Semiconductor, Inc., Seoul, Korea
Amkor Technology Philippines, Inc. Manila, Philippines
Amkor Technology
ANAM Semiconductor
TITLE PACKAGE OUTLINE, MLF2, 9X9mm BODY
SIZE A3
DWG NO 45276
REV 04
SCALE NONE
CUSTOMER DWG XXXX
SHEET 1 OF 3
FORM NO. MDFORM3J.DWG